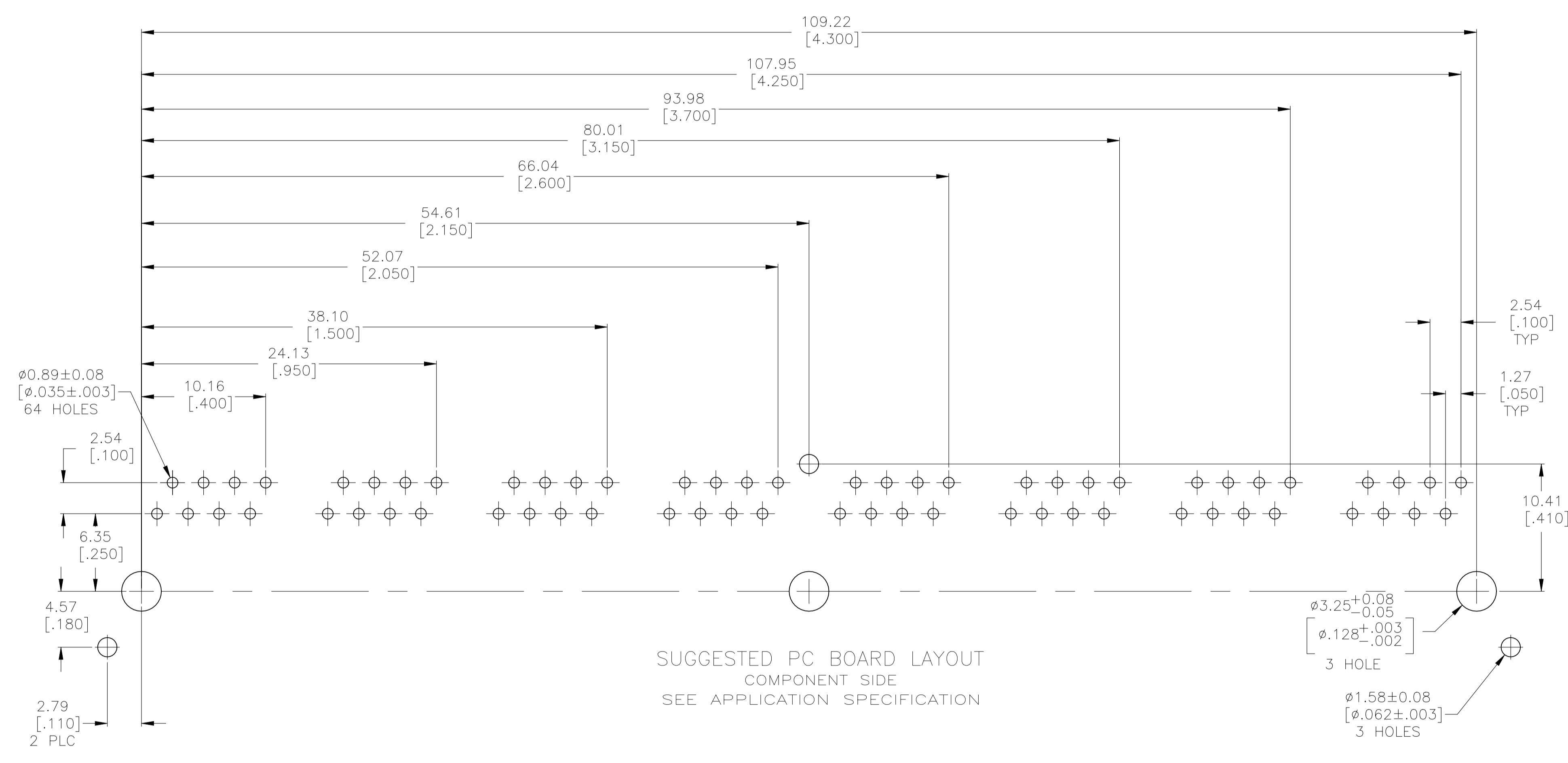
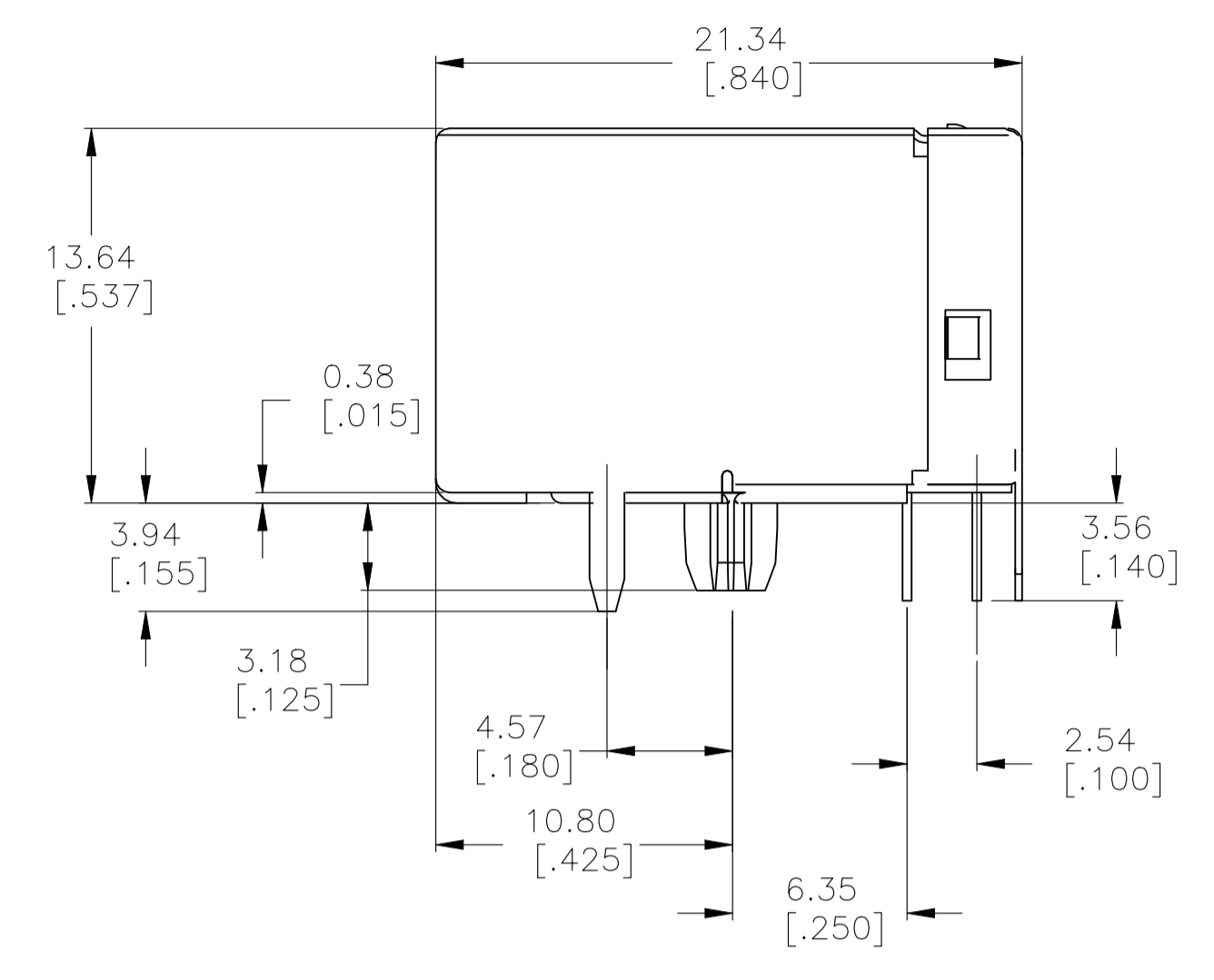
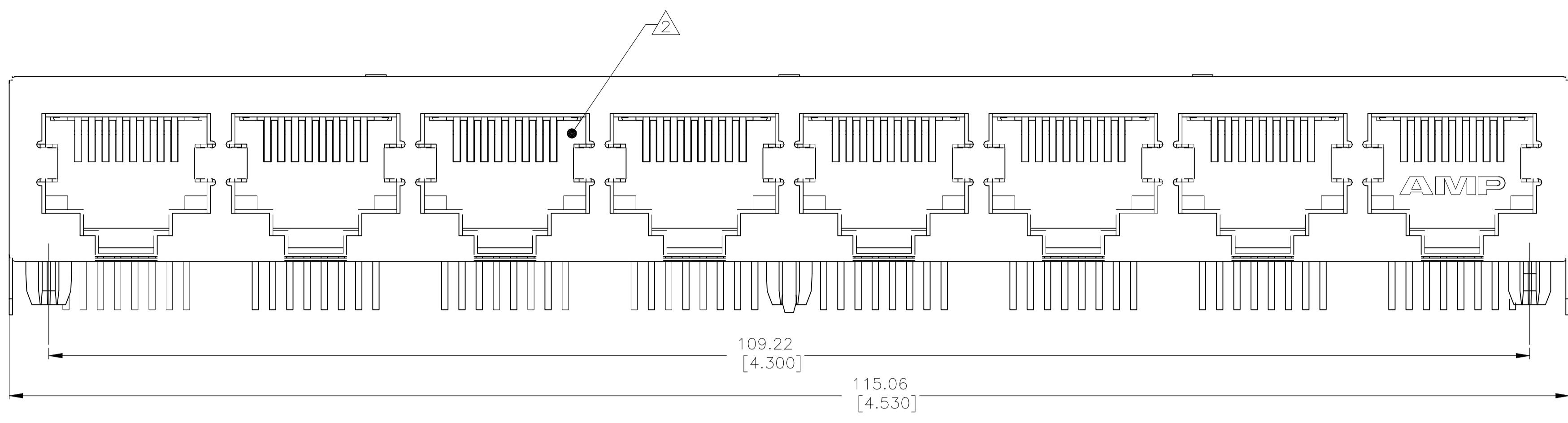


REVISIONS					
REV	DESCRIPTION	DATE	BY	APP'D	
C3	ECR-19-014657	13DEC2020	RR	SZ	



SUGGESTED PC BOARD LAYOUT  
COMPONENT SIDE  
SEE APPLICATION SPECIFICATION



- MATERIAL: HOUSING-HIGH TEMPERATURE NYLON, BLACK, IR COMPATIBLE, UL 94V-0.  
TERMINALS - 0.33 [.013] THICK PHOS BRONZE PLATED WITH 1.27um [.000050] MINIMUM HARD GOLD IN LOCALIZED AREA AND 3.81um [.000150] MINIMUM TIN IN SOLDER AREA OVER 1.27um [.000050] MINIMUM NICKEL UNDERPLATE  
SHIELDS - 0.25 [.010] THICK COPPER ALLOY PLATED WITH 1.27 um [.000050] MINIMUM NICKEL AND 2.03 um [.000080] MINIMUM HOT TIN DIP ON PCB GROUND TABS.
- △ JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART F.
- △ CAUTION: CATEGORY 5 JACK SOLDER TAIL POSITIONS DO NOT FOLLOW SAME NUMBER SEQUENCE AS THAT OF THE TRADITIONAL JACKS.

5558505-1  
PART NO.

THIS DRAWING IS A CONTROLLED DOCUMENT.		DIN W. LONG/L.A.MAYER 04NOV2006 CHK J.WESTMAN 04NOV2006		STE TE Connectivity	
DIMENSIONS: mm [INCHES]		TOLERANCES UNLESS OTHERWISE SPECIFIED: 0. PLC ± - 1. PLC ± - 2. PLC ± 0.25[.010] 3. PLC ± - 4. PLC ± - ANGLES ± -		NAME: S.FLICKINGER 04NOV2006 PRODUCT SPEC: 108-1163-2 APPLICATION SPEC: 114-2048	
MATERIAL: SEE NOTE 1		FINISH: SEE NOTE 1		WEIGHT: 0.000000 A1 00779 C=5558505 CUSTOMER DRAWING	
		SCALE: 4:1		SHEET 1 of 1 REV C3	